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H8/300L SLP 系列

将连接到 I/O 端口的 LED 进行闪烁

要点

将连接到端口的 2 个 LED 交替进行点灯/熄灯。使用定时器 A 的时钟时基功能，将点灯和熄灯的时间设定为 0.5sec。

动作确认器件

H8/38024

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1. 说明

- (1) 如图 1 所示，将连接到端口的 2 个 LED 交替进行点灯/熄灯。
- (2) 使用定时器 A 的时钟时基功能，将点灯和熄灯的时间设定为 0.5sec。
- (3) LED1 连接到端口 9 的 P92 输出管脚，LED2 连接到 P93 输出管脚。
- (4) P92 是大电流端口。

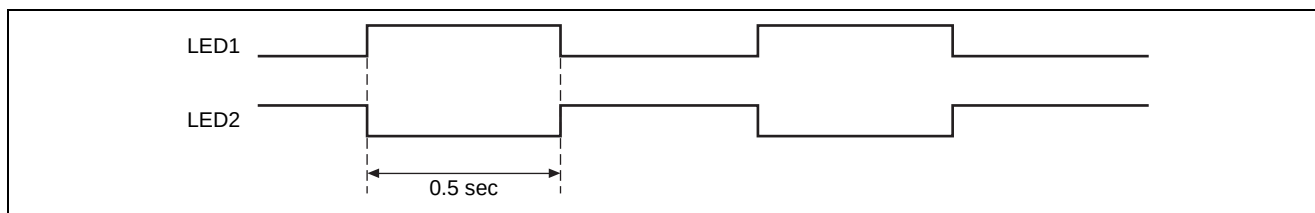


图 1 进行 LED 的闪烁

2. 使用功能的说明

- (1) 本例子将连接到 I/O 端口的 LED 进行闪烁。
 - (a) I/O 端口的框图如图 2 所示，以下说明 I/O 端口的框图：
 - 端口数据寄存器 9 (PDR9) 是保存端口 9 的各个管脚 P95~P90 的数据的 8 位寄存器。如果进行端口 9 的读操作，就直接读 PDR9 的值。因此，不受管脚状态的影响。

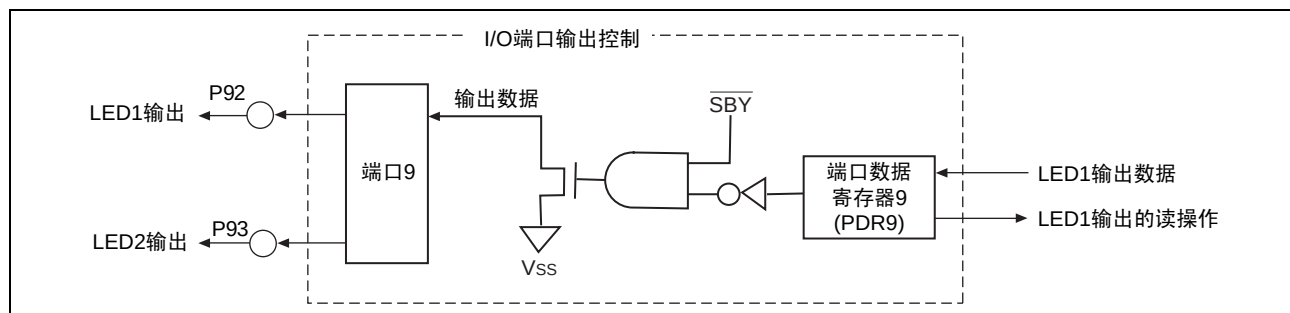


图 2 I/O 端口功能的框图

- (2) 本例子的功能分配如表 1 所示。进行如表 1 所示的功能分配并且将连接到 I/O 端口的 LED 进行闪烁。

表 1 功能分配

功能	功能分配
PSW	以子时钟 (32.768kHz) 的 4 分频为输入的 5 位累加计数器
IEN TA	允许定时器 A 的中断请求
IRRTA	反映定时器 A 中断请求的有无
TMA	将定时器 A 设定为时基功能，TCA 溢出周期设定为 0.5sec
TCA	以子时钟 (32.768kHz) 的 128 分频为输入的 8 位累加计数器
PDR9	保存 P92、P93 输出管脚的数据
P92	LED1 的输出管脚
P93	LED2 的输出管脚

3. 运行说明

(1) 运行说明如图 3 所示。通过如图 3 所示的硬件处理和软件处理，进行连接到 I/O 的 LED 闪烁。

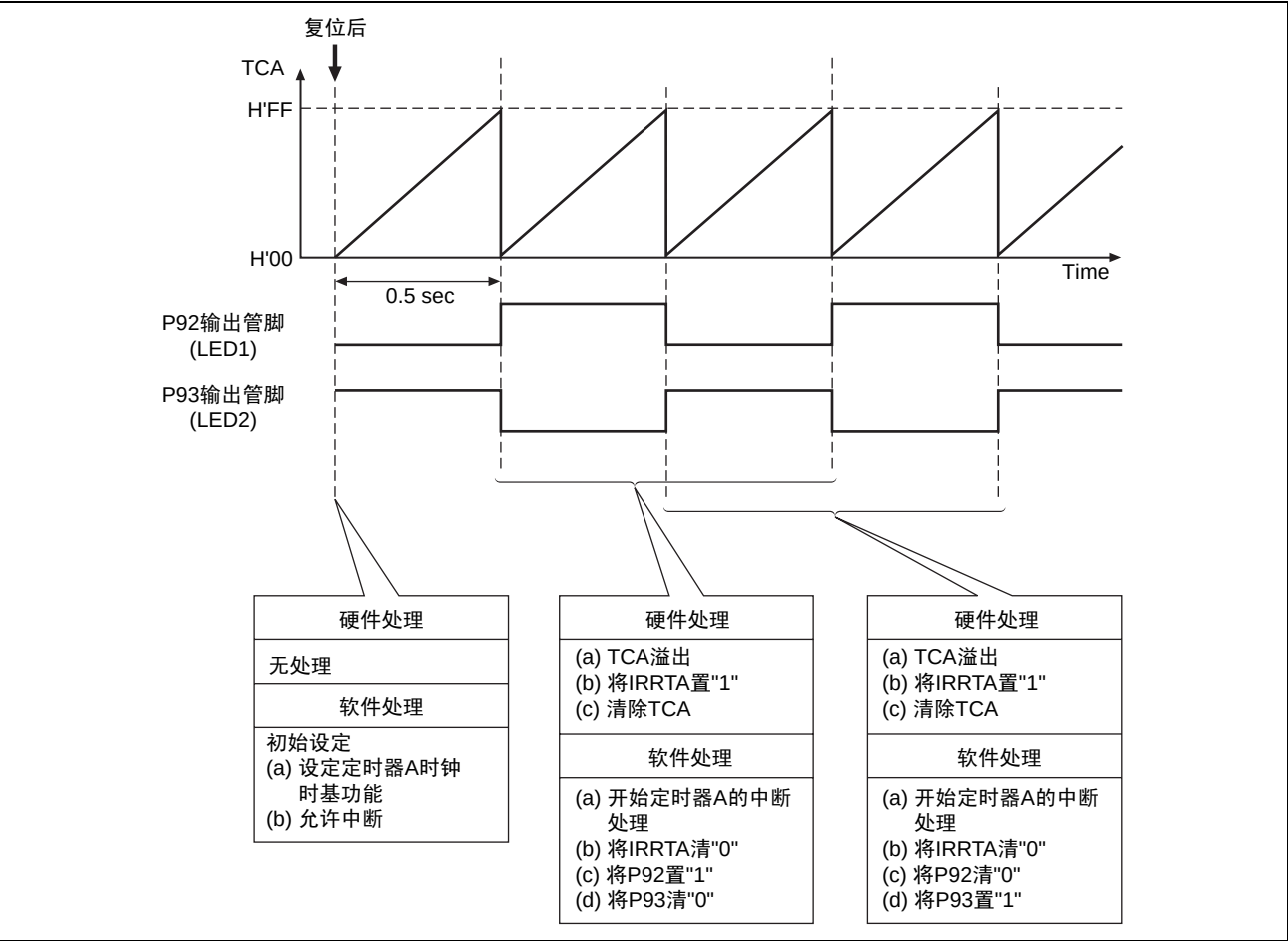


图 3 进行连接到 I/O 端口的 LED 闪烁的运行说明

4. 软件说明

(1) 模块说明

本例子的模块如表 2 所示。

表 2 模块说明

模块名	标号名	功能
主程序	main	设定定时器 A 的时钟时基功能和 I/O 端口，允许中断
端口输出	taint	是定时器 A 的中断处理程序，判断 LED1、LED2 的输出进行输出控制

(2) 参数的说明

本例子不使用参数。

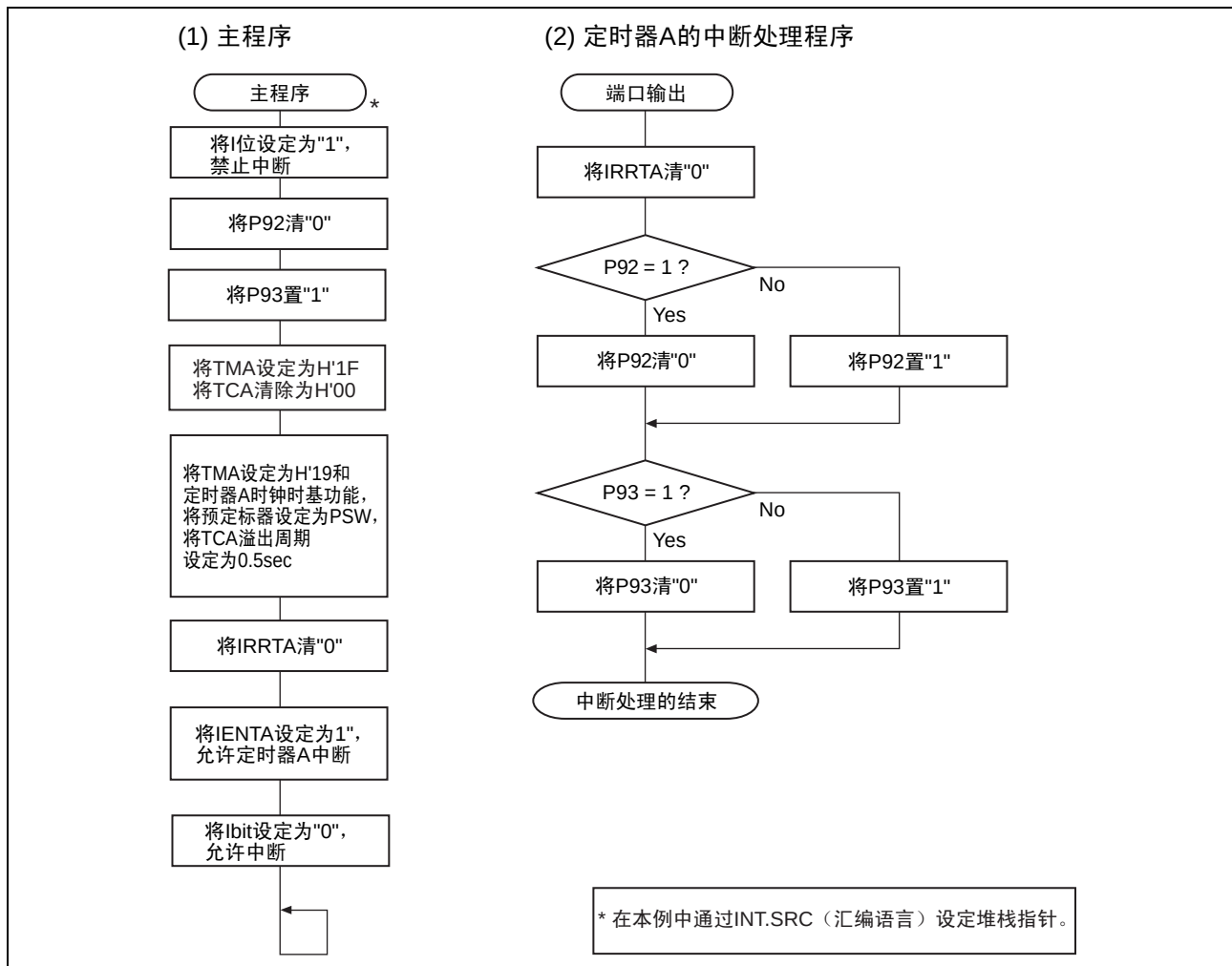
(3) 使用内部寄存器的说明
本例子使用的内部寄存器如表 3 所示。

表 3 使用内部寄存器的说明

寄存器名		功能	地址	设定值
TMA	TMA3	定时器模式寄存器 A (内部时钟选择 3~0) : 当 TMA3="1"、TMA2="0"、TMA1="0"、TMA0="1"时, 将定时器 A 功能设定为时钟时基功能, 预定标器设定为 PSW, TCA 溢出周期设定为 0.5sec	H'FFB0 位 3 位 2 位 1 位 0	TMA3="1" TMA2="0" TMA1="0" TMA0="1"
	TMA2			
	TMA1			
	TMA0			
TCA		定时器计数器 A : 以 PSW 的输出时钟为输入且 0.5sec 溢出的 8 位累加计数器	H'FFB1	H'00
PDR9	P92	端口数据寄存器 9 (端口数据寄存器 93) : 当 P93=0 时, P93 管脚的输出电平为"Low" : 当 P93=1 时, P93 管脚的输出电平为"High"	H'FFDC 位 3	1
	P93	端口数据寄存器 9 (端口数据寄存器 92) : 当 P92=0 时, P92 管脚的输出电平为"Low" : 当 P92=1 时, P92 管脚的输出电平为"High"	H'FFDC 位 2	0
IENR1	IEN TA	中断允许寄存器 1 (定时器 A 中断允许) : 当 IEN TA=0 时, 禁止定时器 A 的中断请求 : 当 IEN TA=1 时, 允许定时器 A 的中断请求	H'FFF3 位 7	1
IRR1	IRRTA	中断请求寄存器 1 (定时器 A 中断请求标志) : 当 IRRTA="0"时, 没有定时器 A 的中断请求 : 当 IRRTA="1"时, 有定时器 A 的中断请求	H'FFF6 位 7	0

(4) 使用 RAM 的说明
本例子不使用 RAM。

5. 流程图



6. 程序清单

6.1 INIT.SRC (程序清单)

```

.EXPORT  _INIT
.IMPORT  _main
;
.SECTION P, CODE
_INIT:
    MOV.W    #H'FF80, R7
    LDC.B    #B'10000000, CCR
    JMP      @_main
;
.END

/*****
/*
/*
/* H8/300L Super Low Power Series
/*      -H8/38024 Series-
/* Application Note
/*
/* 'Flickering of LEDs Connected to I/O Port'
/*
/* Function
/* : I/O Port
/*
/* External Clock : 10MHz
/* Internal Clock : 5MHz
/* Sub Clock      : 32.768kHz
/*
*****/

#include <machine.h>

/*****
/* Symbol Definition
*****/
struct BIT {
    unsigned char  b7:1;    /* bit7 */
    unsigned char  b6:1;    /* bit6 */
    unsigned char  b5:1;    /* bit5 */
    unsigned char  b4:1;    /* bit4 */
    unsigned char  b3:1;    /* bit3 */
    unsigned char  b2:1;    /* bit2 */
    unsigned char  b1:1;    /* bit1 */
    unsigned char  b0:1;    /* bit0 */
};

#define TMA      *(volatile unsigned char *)0xFFB0 /* Timer Mode Register A */
#define TCA      *(volatile unsigned char *)0xFFB1 /* Timer Counter A */
#define PDR9_BIT (*(struct BIT *)0xFFDC) /* Port Data Register 9 */
#define P93      PDR9_BIT.b3 /* Port Data Register 93 */
#define P92      PDR9_BIT.b2 /* Port Data Register 92 */
#define IENR1_BIT (*(struct BIT *)0xFFF3) /* Interrupt Enable Register 1 */
#define IENTA     IENR1_BIT.b7 /* Timer A Interrupt Enable */
#define IRR1_BIT  (*(struct BIT *)0xFFF6) /* Interrupt Request Register 1 */
#define IRRTA     IRR1_BIT.b7 /* Timer A Interrupt Request Flag */

```



```
#pragma interrupt (taint)
/*****
/* Function define
*****/
extern void INIT ( void ); /* SP Set */
void main ( void );
void taint ( void );

/*****
/* Vector Address
*****/
#pragma section V1 /* VECTOR SECT0IN SET */
void (*const VEC_TBL1[])(void) = {
/* 0x00 - 0x0f */
    INIT /* 00 Reset */
};
#pragma section V2 /* VECTOR SECT0IN SET */
void (*const VEC_TBL2[])(void) = {
    taint /* 16 Timer A Interrupt */
};

#pragma section /* P */
/*****
/* Main Program
*****/
void main ( void )
{
    set_imask_ccr(1); /* Interrupt Disable */

    TMA = 0x1F; /* Initialize Timer Counter A */
    TMA = 0x19; /* Initialize TCA Overflow Period */

    IRRTA = 0; /* Clear IRRTA */
    IENTA = 1; /* Timer A Interrupt Enable */

    P92 = 0; /* Initialize P92 Terminal Output */
    P93 = 1; /* Initialize P93 Terminal Output */

    set_imask_ccr(0); /* Interrupt Enable */

    while(1){
        ;
    }
}

/*****
/* Timer A Interrupt
*****/
void taint ( void )
{
    IRRTA = 0; /* Clear IRRTA */
    if ( P92 == 1 ){ /* Turn on LED1 ? */
        P92 = 0; /* Turn off LED1 */
    }
    else{
        P92 = 1; /* Turn on LED1 */
    }
}
```

```

}

if ( P93 == 1 ){
    P93 = 0;
}
else{
    P93 = 1;
}
}

/* Turn on LED2 ? */
/* Turn off LED2 */
/* Turn on LED2 */

```

连接地址的指定

段名	地址
CV1	H'0000
CV2	H'0016
P	H'0100

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修订记录

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		页	修订要点
1.00	2006.03.21	—	初版发行

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